# Heraeus

## **Platinum Resistance Temperature Detector**

## SMD 0805 (V)

The PRTD SMD 0805 is designed for automatic mounting in large volume applications on printed circuit boards where long time stability, interchangeability combined with low costs are important.

Nominal Resistance R0	<b>Tolerance</b> DIN EN 60751 1996-07	<b>Tolerance</b> DIN EN 60751 2009-05	Order Number				
100 Ohm at 0℃	Class B Class 2B	F 0.3 F 0.6	32 207 605 32 207 604				
1000 Ohm at 0℃	Class B Class 2B	F 0.3 F 0.6	32 207 615 32 207 614				
Specification		DIN EN 60751					
Tolerance		Class B (R <sub>0</sub> : ±0.12 %) Class 2B (R <sub>0</sub> : ±0.24 %)					
Temperature range		-50°C to +130°C (Possible working temperatures using volume expansion aligned conductor board material: 150°C) Tolerance Class B or 2B: -50°C up to +130°C					
Temperature coefficient		TCR = 3850 ppm/K			±0,2		
Soldering connection		End-termination galvanic tin plated with Ni-barrier layer			0,35	0,6±0,1	
Long term stability		max. $R_0$ -drift 0.06 % after 1000h at 130 $C$			T		
Environmental conditions		unhoused for dry environments only			5±0,2		
Insulation resistance		> 100 M $\Omega$ at 20°C; > 2 M $\Omega$ at 130°C (glass covering)			2,25		
Measuring current		100 $\Omega$ : 0.3 to 1.0mA 1000 $\Omega$ : 0.1 to 0.3mA (self heating has to be considered)			. 2 . 2	1 , 4±0,25	
Self heating	(	0.8 K/mW at 0℃			0,35		
Reaction time		Flowing water (v= 0.4		= 0.10s = 0.25s	U)		
	,	Air flow (v= 2m/s):	••••	= 2.5s			
Processing instru		face up-mounting: reflow soldering or wave soldering, e. g. double wave $\leq$ 8s / 235°C				RoHS	
Storage life		Min. 9 months (in dry environment)					
Packaging	,	"Face-up" in blister reel, 4000 pcs / reel					
Note		Other tolerances and values of resistance are available on request.					

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## Herael

## Platinum Resistance Temperature Detector

## SMD 0805 (V)

#### Solderability test of SMD type sensor elements

#### Assembly conditions

Benchmarker II 150µm (material FR4 35µm Cu, size 190.5 x 127 x 1.5mm) Layout of PCB: Tested PCB surfaces: chem. Ag, Cu OSP, NiAu, chem. Sn Solder Paste: F640 SA30C5-89 M30 (material SnAgCu 96.5/3.0/0.5)

#### **Tested elements**

Pt 1000 SMD- V 0603 Pt 1000 SMD- V 0805 Pt 1000 SMD- V 1206

#### **Solder conditions**

High and Low Profiles: Atmosphere: Nitrogen and Air



	Peak (max. t	temperature)	time above 217 ℃ in s		
	High	Low	High	Low	
Mid <sup>1</sup>	237 °C	245 °C	60	92	
Mass <sup>2</sup>	231 °C	238 °C	49	68	
Mix <sup>3</sup>	238 °C	248 °C	65	103	

<sup>1</sup> Mid: Position of temperature sensor in the middle of the PCB <sup>2</sup> Mass:

Position of temperature sensor at a big mass area on the PCB

Position of temperature sensors on right and left side on the PCB

Profile High: complete processing time 520 s Profile Low : complete processing time 280 s

#### Result

All tested samples showed a sufficient wetting under the described profiles High and Low, based on a visual soldering point inspection.

All given data should not be construed as guaranteeing specific properties of the product or its suitability for a specific particular application. The data are an extract from a test report with status from July 2010.

We reserve the right to make alterations and technical data printed. All technical data serves as a guideline and does not guarantee particular properties to any products.

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<sup>3</sup> Mix: